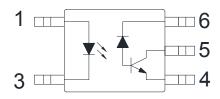


5PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

Description

The KPC457 series consist of a LED. It is a high-speed digital output type photocoupler. And it is packaged in a 5pin mini-flat package.

Schematic



- 1. Anode
- 3. Cathode
- 4. GND(Emitter)
- 5. Vo (Open collector)
- 6. Vcc

Features

- 1. Pb free and RoHS compliant
- 2. 5 pin mini-flat package
- 3. High speed response (tPLH:typ.0.2us, tPHL:typ.0.4us)
- 4. High instantaneous common mode rejection voltage (C_{MH}: Min. 15KV/us, C_ML: Min. -15KV/us)
- 5. High isolation voltage between input and output (Viso: 3750Vrms)
- 6. MSL class 1
- 7. Agency Approvals:
 - UL Approved (No. E169586): UL1577
 - c-UL Approved (No. E169586)
 - VDE Approved (No. 40020973): DIN EN60747-5-5

Applications

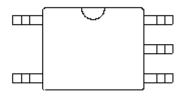
- Computers, measuring instruments, control equipment
- High speed line receivers, high speed logic
- · Telephone sets
- Signal transmission between circuits of different potentials and impedances

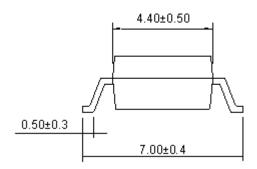


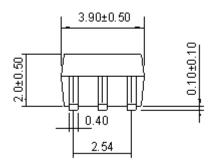
PHOTOCOUPLER

Outside Dimension

Unit: mm

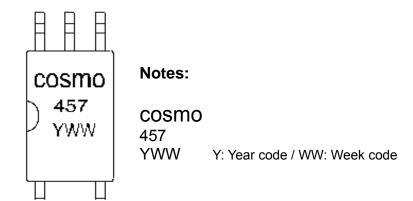






TOLERANCE: ±0.2mm

Device Marking



cosmo

KPC457 Series

5PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

Absolute Maximum Ratings

(Ta=25°℃)

Parameter		Symbol	Rating	Unit
Input	Forward current (*1)	I _F	25	mA
	Peak forward current (*2)	I _{FM}	200	mA
	Reverse voltage	V _R	5	V
	Power dissipation	P _D	45	mW
	Supply voltage	V _{CC}	-0.5 to +30	V
Output	Output voltage	V _{OIL}	-0.5 to +20	V
	Output current	I _{OL}	8	mA
	Power dissipation (*3)	Ро	100	mW
Total power dissipation (*3)		Ptot	100	mW
Isolation voltage 1 minute (*4)		Viso	3750	Vrms
Operating temperature		Topr	-55 to +85	$^{\circ}\!\mathbb{C}$
Storage temperature		Tstg	-55 to +125	$^{\circ}\!\mathbb{C}$
Soldering temperature 10 seconds		Tsol	260	$^{\circ}\!\mathbb{C}$

^{*1} When ambient temperature goes above 70°C, the power dissipation goes down at 0.8mA/°C.

Electro-optical Characteristics

(Ta= 25°ℂ)

	Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input	Forward voltage	V_{F}	I _F =16mA	-	1.7	1.95	V
	Reverse current	I _R	V _R =5V	-	-	10	uA
	Terminal capacitance	Ct	V=0, f=1MHz	-	60	250	pF
Output	High level output current (1)	I _{OH} (1)	$I_F=0, V_{CC}=5.5V, V_O=5.5V$	-	3	500	nA
	High level output current (2)	I _{OH} (2)	I _E =0,V _{CC} =15V,V _O =15V	-	-	1.0	uA
	High level output current (3) (*6)	I _{OH} (3)	11F-0, V _{CC} -15V, V _O -15V	-	-	50	uA
	High level supply current (1)	I _{CCH} (1)	1 =0 \/ =15\/\/ =0non	-	0.02	1.0	uA
	High level supply current (2) (*6)	I _{CCH} (2)	$I_F=0,V_{CC}=15V,V_O=Open$	_	-	2.0	uA
	Low level supply current	I _{CCL}	I _F =16mA,V _{CC} =15V,V _O =Open	-	120	-	uA
	Low level supply voltage	V_L	I _F =16mA,V _{CC} =4.5V,I _O =2.4mA	_	-	0.4	V
Transfer Charac- teristics	Current transfer ratio (1)	CTR(1)	I _F =16mA,V _{CC} =4.5V,V _O =0.4V,	19	-	50	%
	Current transfer ratio (2) (*6)	CTR(2)	R _L =1.9KΩ	15	-	-	%
	Isolation resistance	R _{ISO}	DC=500V,40 to 60%RH	5x10 ¹⁰	1x10 ¹¹	-	Ω
	Floating capacitance	C_{f}	V=0,f=1MH _Z	-	0.6	1.0	pF
	"High>Low" propagation delay time	t _{PHL}	I _F =16mA,Vcc=5V,	-	0.2	0.8	us
	"High>Low" propagation delay time	t _{PLH}	$R_L=1.9K\Omega$	-	0.4	0.8	us
	Instantaneous common mode rejection voltage (High level output)	Смн	$I_F=0,V_{CC}=5V, \ V_{CM}=1.0KV(p-p), \ R_L=1.9K\Omega$	15	30	-	KV/us

^{*2} When ambient temperature goes above 70°C, the power dissipation goes down at 1.5mW/°C.

^{*3} When ambient temperature goes above 70°C, the power dissipation goes down at 1.8mW/°C.

^{*4 40} to 80%RH AC for 1 minute=60HZ.



5PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

Instantaneous common mode rejection voltage (High level output)	I_F =16mA, V_{CC} =5V, V_{CM} =1.0KV(p-p), R_L =1.9KΩ	-15	-30	-	KV/us
---	---	-----	-----	---	-------

^{*5} It shall connect a by-pass capacitor of 0.01uF or more between Vcc (pin 6) and GND(pin 4) near the device ,when it measures transfer characteristics and the output side characteristics.
*6 Ta=0 to 70°C.





5PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

Fig.1 Forward Current vs. Ambient Temperature

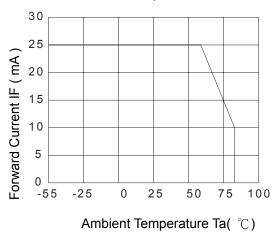


Fig.3 Forward Current vs. Forward Voltage

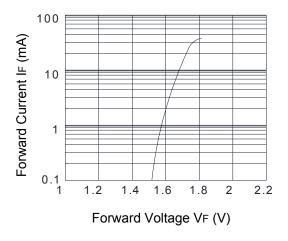


Fig.5 Output Current vs. Output Voltage

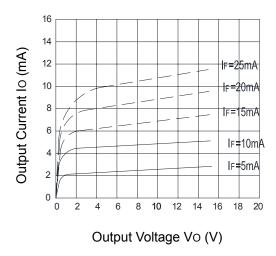


Fig.2 Power Dissipation vs. Ambient Temperature

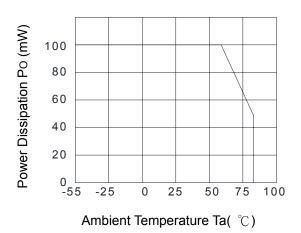


Fig.4 Current Transfer Ratio vs. Forward Current

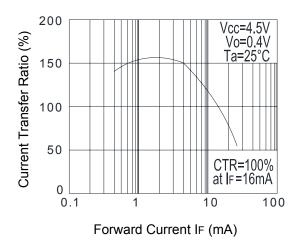
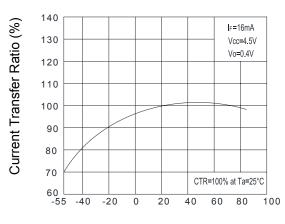


Fig.6 Current Transfer Ratio vs. Ambient Temperature



Ambient Temperature Ta(°C)

5PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

Fig.7 Pulse Width Distortion vs. Ambient Temperature

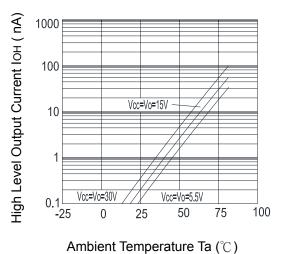
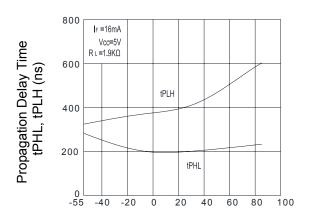


Fig.8 Propagation Delay Time vs. Ambient Temperature



Ambient Temperature Ta (°C)



5PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

Recommended Soldering Conditions

(a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature : 10 sec
 ■ Time of temperature higher than 230°C : 30-60 sec
 ■ Time to preheat temperature from 180~190°C : 60-120 sec

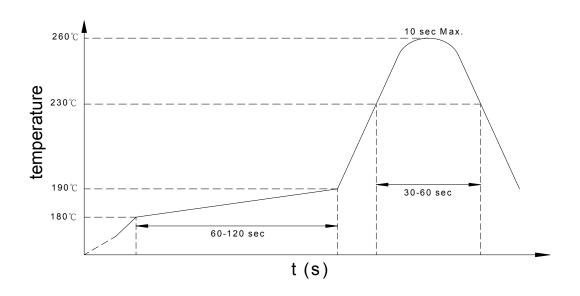
■ Time(s) of reflow: Two

■ Flux : Rosin flux containing small amount of chlorine (The

flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time : 10 seconds or less

■ Preheating conditions : 120°C or below (package surface temperature)

■ Time(s) of reflow : One

■ Flux: Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

■ Fluxes : Avoid removing the residual flux with freon-based and chlorine-based

cleaning solvent.

Avoid shorting between portion of frame and leads.



Numbering System

KPC457 (Z)

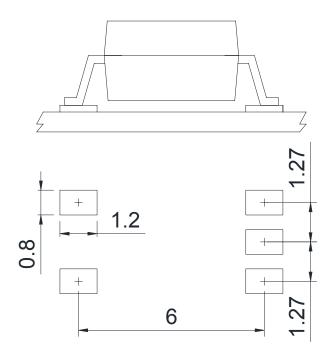
Notes:

KPC457 = Part No.

Z = Tape and reel option (TLD, TRU)

Option	Description	Packing quantity
TLD	TLD tape & reel option	3000 units per reel
TRU	TRU tape & reel option	3000 units per reel

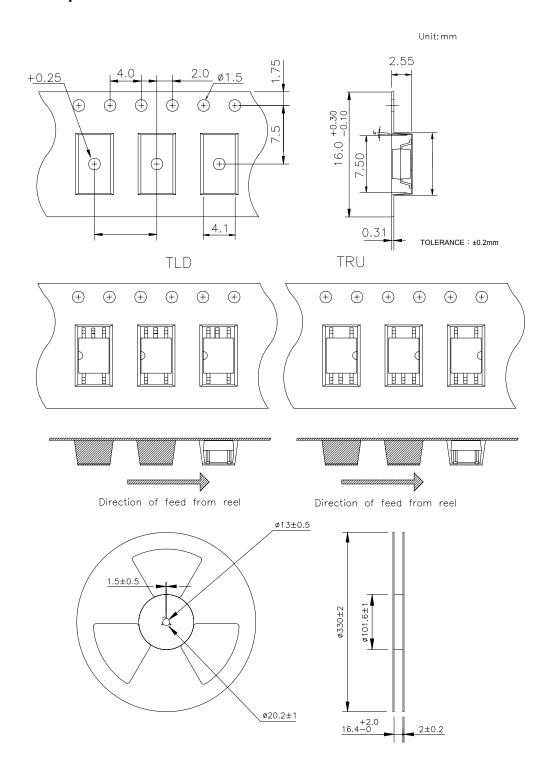
Recommended Pad Layout for Surface Mount Lead Form



Unit: mm



SOP Carrier Tape & Reel



KPC457 Series PHOTOCOUPLER



Application Notice

The statements regarding the suitability of products for certain types of applications are based on cosmo's knowledge of general applications of cosmo products. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to verify the specifications are suitable for use in a particular application. Customers are solely responsible for all aspects of their own product design or applications. The parameters provided in the datasheet may vary in different applications and performance may vary over time. All operating parameters (including typical parameters) must be validated by customer's technical experts for different applications, cosmo assumes no liability for customer' product design or applications. Product specifications do not expand or otherwise change cosmo's terms and conditions of purchase, including but not limited to the warranty expressed therein.

When using cosmo products, please comply with safety standards and instructions. cosmo has no liability and responsibility to the damage caused by improper use of the instructions specified in the specifications.

cosmo products are designed for use in general electronic equipment such as telecommunications, office automation equipments, personal computers, test and measurement equipments, consumer electronics, industrial control, instrumentation, audio, video.

cosmo devices shall not be used in equipment that requires higher level of reliability and safety, such as nuclear power control equipment, telecommunication equipment(trunk lines), space application, medical and other life supporting equipments, and equipment for aircraft, military, automotive or any other application that can cause human injury or death.

cosmo reserves the right to change the specifications, data, characteristics, structure, materials and other contents at any time without notice. Please contact cosmo to obtain the latest specification.

cosmo disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.